



# TC1320

## 8-Bit Digital-to-Analog Converter with Two-Wire Interface

### Features

- 8-bit Digital-to-Analog Converter
- $\pm 2$  LSB INL
- $\pm 0.8$  LSB DNL
- 2.7-5.5V Single Supply Operation
- Simple SMBus/I<sup>2</sup>C™ Serial Interface
- Low Power: 350 $\mu$ A Operation, 0.5 $\mu$ A Shutdown
- 8-Pin SOIC and 8-Pin MSOP Packages

### Applications

- Programmable Voltage Sources
- Digital Controlled Amplifiers/Attenuators
- Process Monitoring and Control

### Device Selection Table

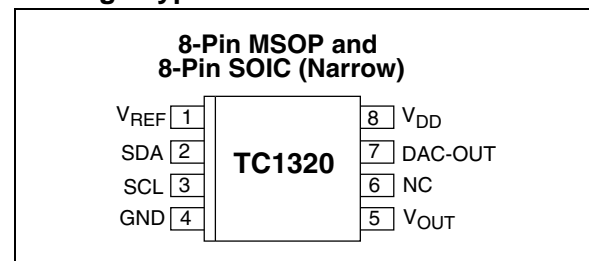
Part Number	Package	Temperature Range
TC1320EOA	8-Pin SOIC (Narrow)	-40°C to +85°C
TC1320EUA	8-Pin MSOP	-40°C to +85°C

### General Description

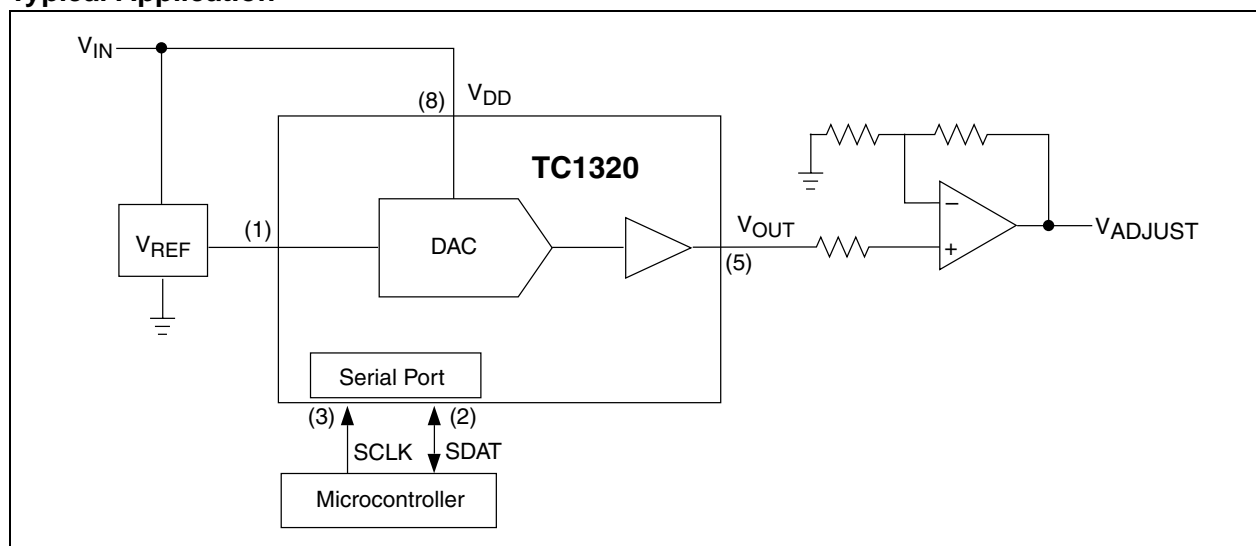
The TC1320 is a serially accessible 8-bit voltage output digital-to-analog converter (DAC). The DAC produces an output voltage that ranges from ground to an externally supplied reference voltage. It operates from a single power supply that can range from 2.7V to 5.5V, making it ideal for a wide range of applications. Built into the part is a Power-on Reset function that ensures that the device starts at a known condition.

Communication with the TC1320 is accomplished via a simple 2-wire SMBus/I<sup>2</sup>C™ compatible serial port with the TC1320 acting as a slave only device. The host can enable the SHDN bit in the CONFIG register to activate the Low Power Standby mode.

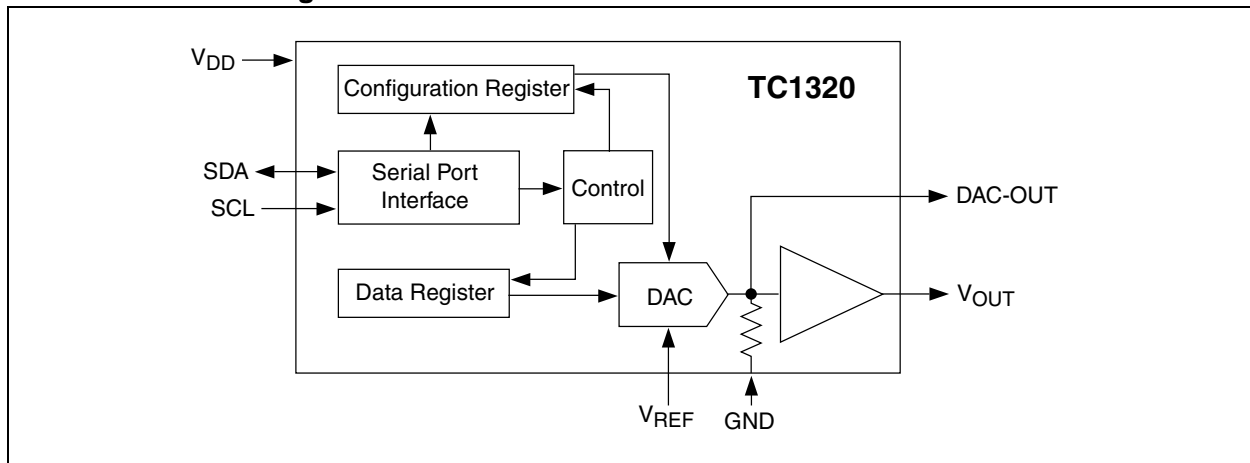
### Package Type



### Typical Application



## Functional Block Diagram



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings\*

Supply Voltage ( $V_{DD}$ )	+6V
Voltage on any Pin .. (GND – 0.3V) to ( $V_{DD}$ + 0.3V)	
Current on any Pin	±50mA
Package Thermal Resistance ( $\theta_{JA}$ )	330°C C/W
Operating Temperature ( $T_A$ )	See Below
Storage Temperature ( $T_{STG}$ )	-65°C to +150°C

\*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

### TC1320 ELECTRICAL SPECIFICATIONS

Electrical Characteristics: $V_{DD} = 2.7V$ to $5.5V$ , $-40^\circ C \leq T_A \leq +85^\circ C$ , $V_{REF} = 1.2V$ unless otherwise noted.						
Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
<b>Power Supply</b>						
$V_{DD}$	Supply Voltage	2.7	350	500	$\mu A$	
$I_{DD}$	Operating Current	—	0.35	0.5	mA	$V_{DD} = 5.5V$ , $V_{REF} = 1.2V$ Serial Port Inactive ( <b>Note 1</b> )
$I_{DD-STANDBY}$	Standby Supply Current	—	0.1	1	$\mu A$	$V_{DD} = 3.3V$ Serial Port Inactive ( <b>Note 1</b> )
<b>Static Performance - Analog Section</b>						
	Resolution	—	—	8	Bits	
INL	Integral Non-Linearity at FS, $T_A = +25^\circ C$	—	—	±2	LSB	( <b>Note 2</b> )
FSE	Full Scale Error	—	—	±3	%FS	
DNL	Differential Non-Linearity, $T_A = +25^\circ C$	—	—	±0.8	LSB	All Codes ( <b>Note 2</b> )
$V_{OS}$	Offset Error at $V_{OUT}$	—	±0.3	±8	mV	( <b>Note 2</b> )
$TCV_{OS}$	Offset Error Tempco at $V_{OUT}$	—	10	—	$\mu V/^\circ C$	
PSRR	Power Supply Rejection Ratio	—	80	—	dB	$V_{DD}$ at DC
$V_{REF}$	Voltage Reference Range	0	—	$V_{DD} - 1.2$	V	
$I_{REF}$	Reference Input Leakage Current	—	—	±1.0	$\mu A$	
$V_{SW}$	Voltage Swing	0	—	$V_{REF}$	V	$V_{REF} \leq (V_{DD} - 1.2V)$
$R_{OUT}$	Output Resistance @ $V_{OUT}$	—	5	—	$\Omega$	$R_{OUT} (\Omega)$
$I_{OUT}$	Output Current (Source or Sink)	—	2	—	mA	
$I_{SC}$	Output Short-Circuit Current	—	30	50	mA	Source
	$V_{DD} = 5.5V$	—	20	50	mA	Sink
<b>Dynamic Performance</b>						
SR	Voltage Output Slew Rate	—	0.8	—	V/ $\mu s$	
$t_{SETTLE}$	Output Voltage Full Scale Settling Time	—	10	—	$\mu sec$	
$t_{WU}$	Wake-up Time	—	20	—	$\mu s$	
	Digital Feed Through and Crosstalk	—	5	—	nV-s	SDA = $V_{DD}$ , SCL = 100kHz
<b>Serial Port Interface</b>						
$V_{IH}$	Logic Input High	2.4	—	$V_{DD}$	V	
$V_{IL}$	Logic Input Low	—	—	0.6	—	
$V_{OL}$	SDA Output Low	—	—	0.4	V	$I_{OL} = 3mA$ (Sinking Current) $I_{OL} = 6mA$
		—	—	0.6	V	
$C_{IN}$	Input Capacitance SDA, SCL	—	5	0.4	pF	
$I_{LEAK}$	I/O Leakage	—	—	±1.0	$\mu A$	

**Note 1:** SDA and SCL must be connected to  $V_{DD}$  or GND.

**Note 2:** Measured at  $V_{OUT} \geq 50mV$  referred to GND to avoid output buffer clipping.

## TC1320 ELECTRICAL SPECIFICATIONS (CONTINUED)

Electrical Characteristics: $V_{DD} = 2.7V$ to $5.5V$ , $-40^{\circ}C \leq T_A \leq +85^{\circ}C$ , $V_{REF} = 1.2V$ unless otherwise noted.						
Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
<b>Serial Port AC Timing</b>						
$f_{SMB}$	SMBus Clock Frequency	10	—	100	kHz	
$t_{IDLE}$	Bus Free Time Prior to New Transition	4.7	—	—	$\mu$ sec	
$t_{H(START)}$	START Condition Hold Time	4.0	—	—	$\mu$ sec	
$t_{SU(START)}$	START Condition Setup Time	4.7	—	—	$\mu$ sec	90% SCL to 10% SDA (for Repeated START Condition)
$t_{SU(STOP)}$	STOP Condition Setup Time	4.0	—	—	$\mu$ sec	
$t_{H-DATA}$	Data In Hold Time	100	—	—	nsec	
$t_{SU-DATA}$	Data In Setup Time	100	—	—	nsec	
$t_{LOW}$	Low Clock Period	4.7	—	—	$\mu$ sec	10% to 10%
$t_{HIGH}$	High Clock Period	4	—	—	$\mu$ sec	90% to 90%
$t_F$	SMBus Fall Time	—	—	300	nsec	90% to 10%
$t_R$	SMBus Rise Time	—	—	1000	nsec	10% to 90%
$t_{POR}$	Power-on Reset Delay	—	500	—	$\mu$ sec	$V_{DD} \geq V_{POR}$ (Rising Edge)

**Note 1:** SDA and SCL must be connected to  $V_{DD}$  or GND.

**Note 2:** Measured at  $V_{OUT} \geq 50mV$  referred to GND to avoid output buffer clipping.

## 2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

**TABLE 2-1: PIN FUNCTION TABLE**

Pin Number	Symbol	Type	Description
1	V <sub>REF</sub>	Input	Input. Voltage Reference Input can range from 0V to 1.2V below V <sub>DD</sub> .
2	SDA	Bi-Directional	Bi-directional. Serial data is transferred on the SMBus in both directions using this pin.
3	SCL	Input	Input. SMBus serial clock. Clocks data into and out of the TC1320.
4	GND	Power	Ground.
5	V <sub>OUT</sub>	Output	Output. Buffered DAC output voltage. This voltage is a function of the reference voltage and the contents of the DATA register.
6	NC	None	No connection.
7	DAC-OUT	Output	Output. Unbuffered DAC output voltage. This voltage is a function of the reference voltage and the contents of the DATA register. This output is unbuffered and care must be taken that the pin is connected only to a high-impedance node.
8	V <sub>DD</sub>	Power	Positive power supply input. See electrical specifications.



## 4.0 SERIAL PORT OPERATION

The Serial Clock input (SCL) and bi-directional data port (SDA) form a 2-wire bi-directional serial port for programming and interrogating the TC1320. The following conventions are used in this bus architecture:

**TABLE 4-1: TC1320 SERIAL BUS CONVENTIONS**

Term	Explanation
Transmitter	The device sending data to the bus.
Receiver	The device receiving data from the bus.
Master	The device which controls the bus: initiating transfers (START), generating the clock, and terminating transfers (STOP).
Slave	The device addressed by the master.
START	A unique condition signaling the beginning of a transfer indicated by SDA falling (High - Low) while SCL is high.
STOP	A unique condition signaling the end of a transfer indicated by SDA rising (Low - High) while SCL is high.
ACK	A Receiver Acknowledges the receipt of each byte with this unique condition. The Receiver drives SDA low during SCL high of the ACK clock pulse. The Master provides the clock pulse for the ACK cycle.
Busy	Communication is not possible because the bus is in use.
Not Busy	When the bus is IDLE, both SDA and SCL will remain high.
Data Valid	The state of SDA must remain stable during the High period of SCL in order for a data bit to be considered valid. SDA only changes state while SCL is low during normal data transfers. (See START and STOP conditions.)

All transfers take place under control of a host, usually a CPU or microcontroller, acting as the Master, which provides the clock signal for all transfers. The TC1320 *always* operates as a Slave. The serial protocol is illustrated in Figure 3-1. All data transfers have two phases; all bytes are transferred MSB first. Accesses are initiated by a START condition (START), followed by a device address byte and one or more data bytes. The device address byte includes a Read/Write selection bit. Each access must be terminated by a STOP Condition (STOP). A convention called *Acknowledge* (ACK) confirms receipt of each byte. Note that SDA can change only during periods when SCL is LOW (SDA changes while SCL is HIGH is reserved for START and STOP Conditions).

### 4.1 START Condition (START)

The TC1320 continuously monitors the SDA and SCL lines for a START condition (a HIGH to LOW transition of SDA while SCL is HIGH), and will not respond until this condition is met.

### 4.2 Address Byte

Immediately following the START Condition, the host must transmit the address byte to the TC1320. The 7-bit SMBus address for the TC1320 is 1001000. The 7-bit address transmitted in the serial bit stream must match for the TC1320 to respond with an Acknowledge (indicating the TC1320 is on the bus and ready to accept data). The eighth bit in the Address Byte is a Read/Write bit. This bit is a 1 for a read operation, or 0 for a write operation. During the first phase of any transfer, this bit will be set = 0 to indicate that the command byte is being written.

### 4.3 Acknowledge (ACK)

Acknowledge (ACK) provides a positive handshake between the host and the TC1320. The host releases SDA after transmitting eight bits, then generates a ninth clock cycle to allow the TC1320 to pull the SDA line LOW to Acknowledge that it successfully received the previous eight bits of data or address.

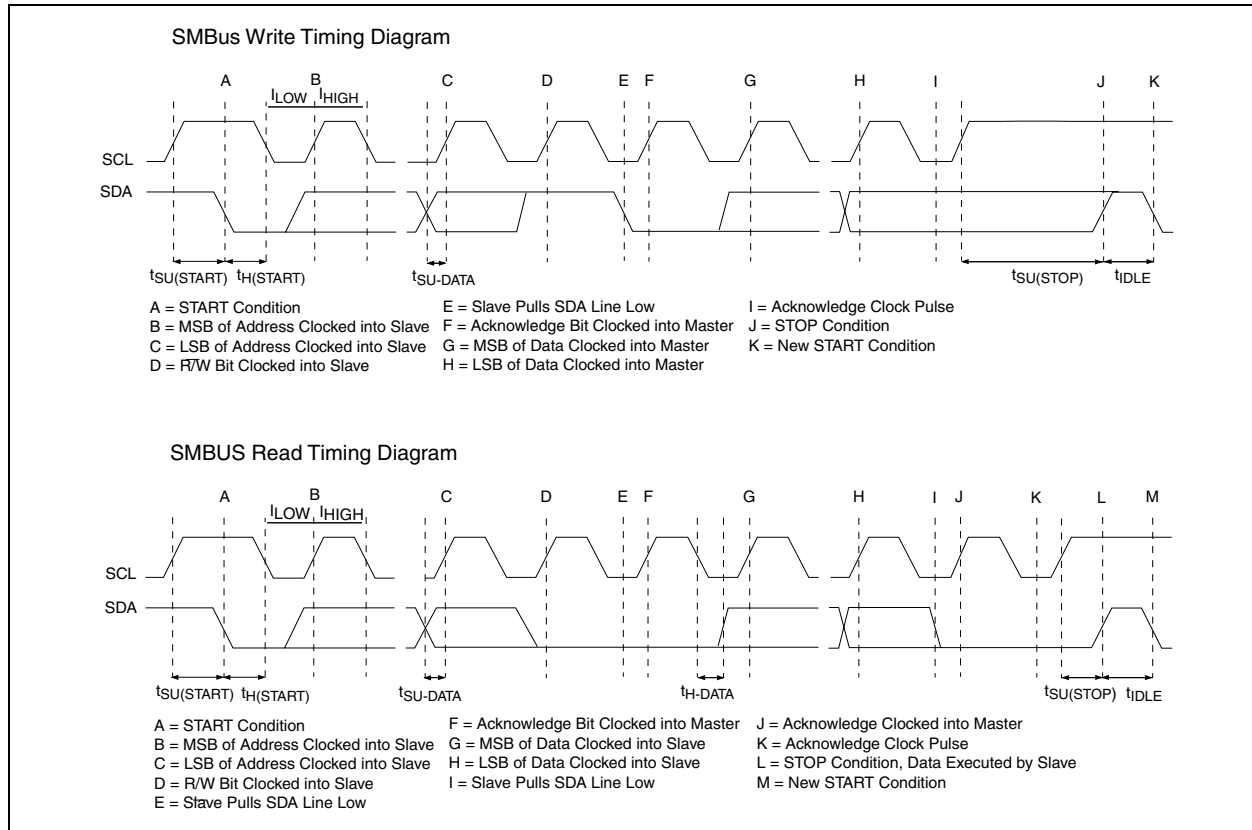
### 4.4 Data Byte

After a successful ACK of the address byte, the host must transmit the data byte to be written, or clock out the data to be read. (See the appropriate timing diagrams.) ACK will be generated after a successful write of a data byte into the TC1320.

### 4.5 STOP Condition (STOP)

Communications must be terminated by a STOP condition (a LOW to HIGH transition of SDA while SCL is HIGH). The STOP Condition must be communicated by the transmitter to the TC1320. Refer to Figure 4-1, Timing Diagrams for serial bus timing.

**FIGURE 4-1: TIMING DIAGRAMS**



## 4.6 Register Set and Programmer's Model

**TABLE 4-2: TC1320 COMMAND SET (SMBus READ\_BYTE AND WRITE\_BYTE)**

Command Byte Description		
Command	Code	Function
RWD	00h	Read/Write Data (DATA)
RWCR	01h	Read/Write Configuration (CONFIG)

**TABLE 4-3: CONFIGURATION REGISTER (CONFIG), 8-BIT, READ/WRITE**

Configuration Register (CONFIG)							
D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]
Reserved							SHDN
Bit	POR	Function	Type	Operation			
D[0]	0	Standby Switch	Read/Write	1 = Standby 0 = Normal			
D[7]-D[1]	0	Reserved; Always returns Zero when Read	N/A	N/A			



**TABLE 4-4: DATA REGISTER (DATA), 8-BIT, READ/WRITE**

Data Register (DATA)							
D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]
MSB	X	X	X	X	X	X	LSB

The DAC output voltage is a function of reference voltage and the binary value of the contents of the Data register. The transfer function is given by the expression:

**EQUATION 4-1:**

$$V_{OUT} = V_{REF} \times \left[ \frac{DATA}{256} \right]$$

## 4.7 Register Set Summary

The TC1320's register set is summarized in Table 4-5 below. All registers are 8-bits wide.

**TABLE 4-5: TC1320 REGISTER SET SUMMARY**

Name	Description	POR State	Read	Write
Data	Data Register	0000 0000b	X	X
Config	CONFIG Register	0000 0000b	X	X

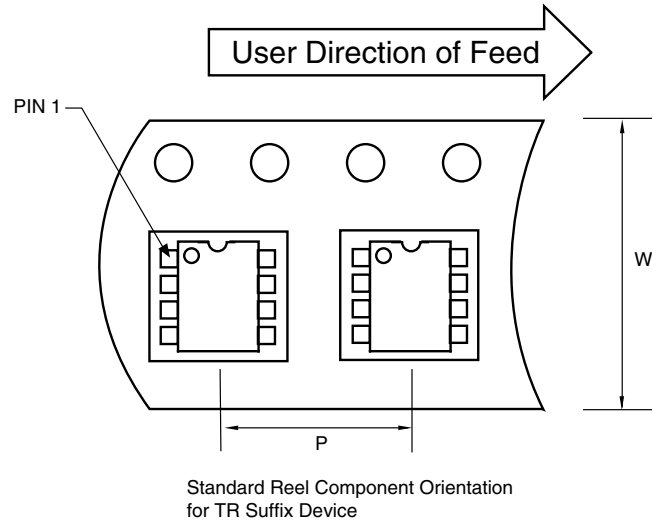
## 5.0 PACKAGING INFORMATION

### 5.1 Package Marking Information

Package marking data not available at this time.

### 5.2 Taping Forms

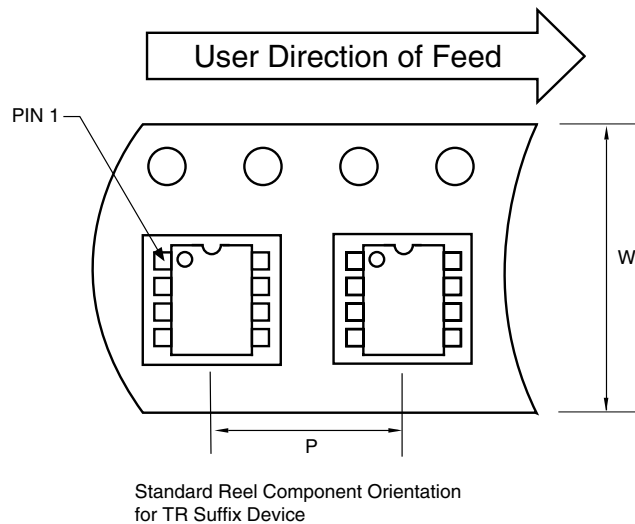
#### Component Taping Orientation for 8-Pin MSOP Devices



Carrier Tape, Number of Components Per Reel and Reel Size

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
8-Pin MSOP	12 mm	8 mm	2500	13 in

#### Component Taping Orientation for 8-Pin SOIC (Narrow) Devices

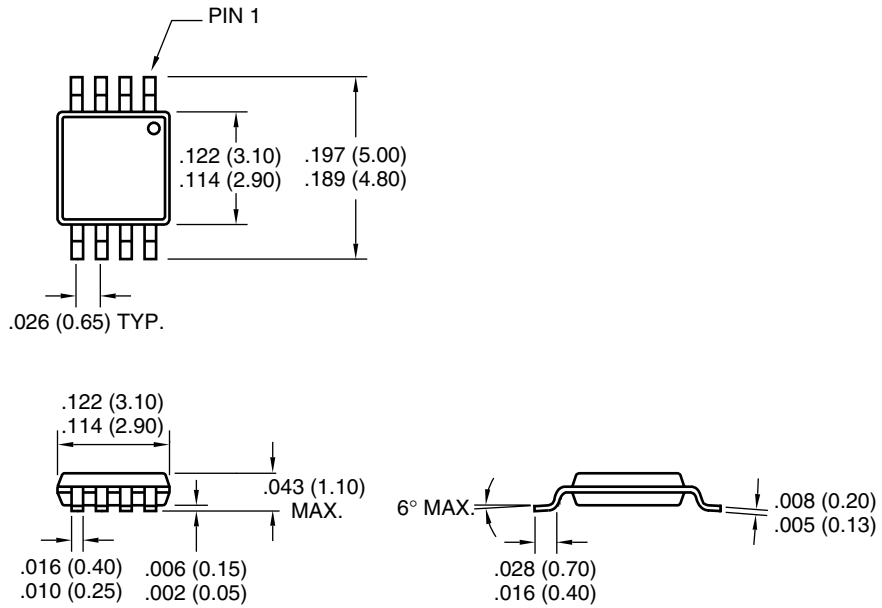


Carrier Tape, Number of Components Per Reel and Reel Size

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
8-Pin SOIC (N)	12 mm	8 mm	2500	13 in

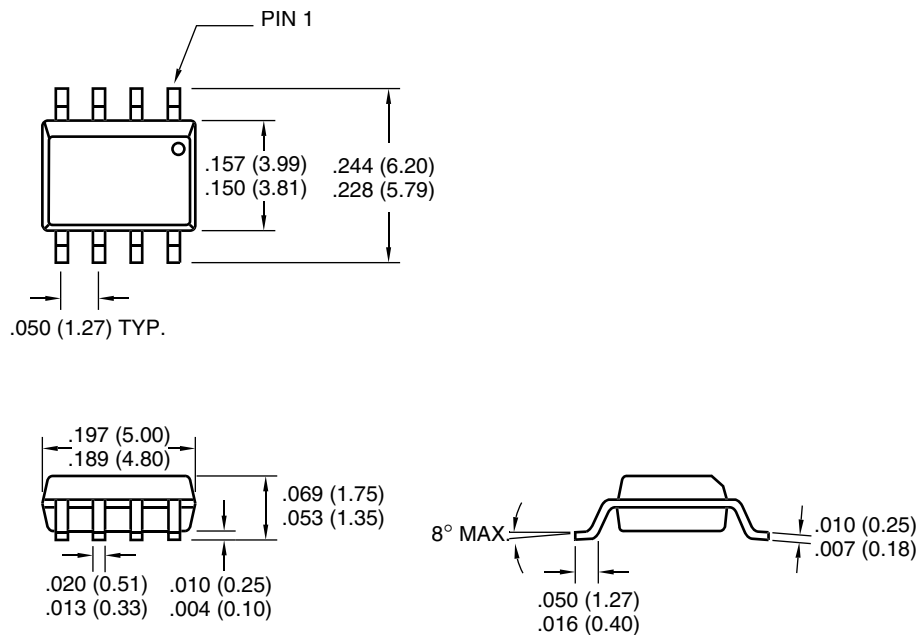
5.3 Package Dimensions

8-Pin MSOP



Dimensions: inches (mm)

8-Pin SOIC



Dimensions: inches (mm)

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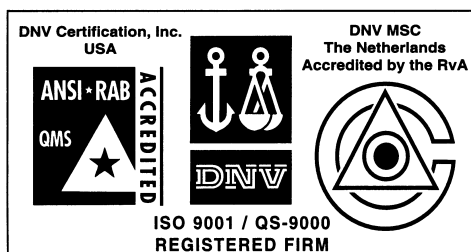
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